

# AOZ22559QI 25V/15A Synchronous EZBuck™ Regulator

### **General Description**

The AOZ22559QI is a high-efficiency, easy-to-use DC/DC synchronous buck regulator that operates up to 25V. The device is capable of supplying 15A of continuous output current with an output voltage adjustable down to 0.6V ( $\pm 1.0\%$ ).

A proprietary constant on-time PWM control with input feed-forward results in ultra-fast transient response while maintaining relatively constant switching frequency over the entire input voltage range. A low 70 ns minimum on-time enables very low output voltages at ultra-high operating frequencies.

Integrated AC ripple injection enables all-ceramic low ESR output filter capacitors and smaller PCB footprint with no external components needed.

Selectable PFM mode optimizes light load efficiency while forced PWM mode maintains constant frequency for lower harmonic noise.

The device features multiple protection functions such as  $V_{CC}$  under-voltage lockout, cycle-by-cycle current limit, output over-voltage protection, short-circuit protection, and thermal shutdown.

The AOZ22559QI is available in a 4mm×4mm QFN-30L package and is rated over a -40°C to +85°C ambient temperature range.

#### **Features**

- Wide input voltage range
  - 5.5V to 25V
- Support Intel I<sub>TDC</sub> up to 15A
- Support Intel I<sub>CCMAX</sub> up to 30A
- Output voltage adjustable down to 0.6V (±1.0%)
- Low R<sub>DS(ON)</sub> internal NFETs
  - 11 mΩ high-side
  - 4mΩ low-side
- · Constant on-time with input feed-forward
- Programmable Switching Frequency Range up to 1MHz (For 12  $V_{IN}$  to 1  $V_{OUT}$ )
- Selectable PFM or forced PWM light load operation
- Ceramic capacitor stable
- Remote sense
- Adjustable current limit setting
- Adjustable soft-start
- Power Good output
- Integrated bootstrap diode
- Under-voltage protection and over-voltage protection
- Cycle-by-cycle current limit
- Short-circuit protection
- Thermal shutdown
- Thermally enhanced 30-pin 4mm×4mm QFN

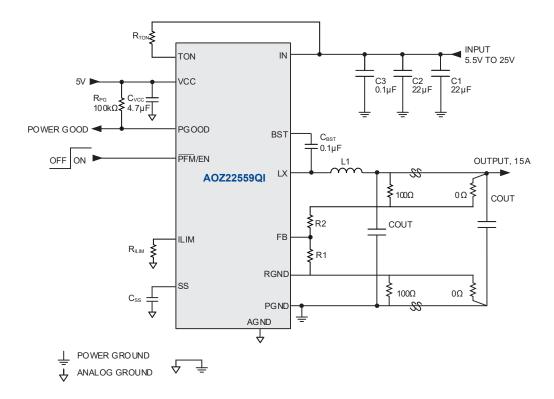
#### **Applications**

- Compact PCs and gaming systems
- Set-top boxes and LCD TVs
- Server & Storage systems
- Datacom and networking
- Embedded Computing
- Point-of-load DC/DC Converters

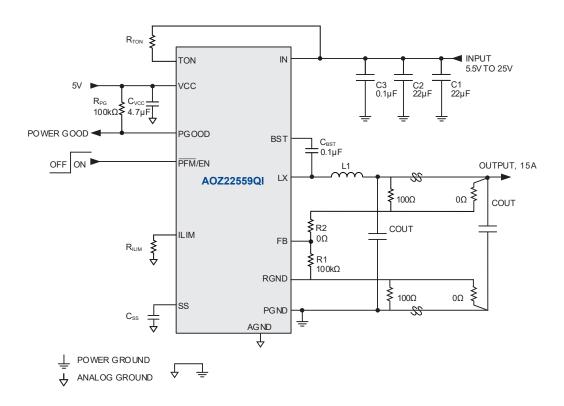




# **Typical Application**

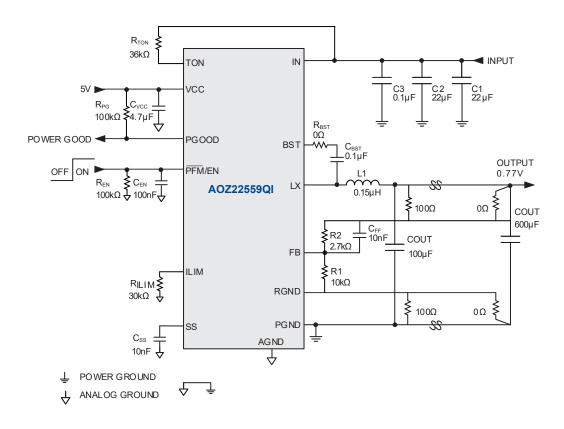


# **Output Voltage 0.6V Recommended Circuit**





# **Intel VNNAON Application Circuit Output Voltage 0.77V**





# **Ordering Information**

Part Number	Ambient Temperature Range	Package	Environmental	
AOZ22559QI	-40°C to +85°C	QFN4x4-30L	Green	



AOS products are offered in packages with Pb-free plating and compliant to RoHS standards. Please visit https://aosmd.com/sites/default/files/media/AOSGreenPolicy.pdf for additional information.

# **Pin Configuration**

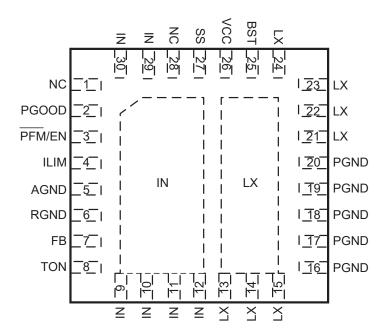


Figure 1. AOZ22559QI 30-Pin 4mmx4mm QFN

Rev. 1.1 October 2023 **www.aosmd.com** Page 4 of 19



# **Pin Description**

Pin Number	Pin Name	Pin Function
1, 28	NC	No Connect.
2	PGOOD	Power Good Signal Output. PGOOD is an open-drain output used to indicate the status of the output voltage. It is internally pulled low when the output voltage is 15% lower than the nominal regulation voltage for or 20% higher than the nominal regulation voltage. PGOOD is pulled low during soft-start and shut down.
3	PFM /EN	Multi-function pin. Enable Input and PFM Selection Input. AOZ22559QI is enabled when EN is pulled high. The device shuts down when EN is pulled low. Assert EN to high for power-up after IN are well supplied. Power-off the device by EN off is suggested. Set this pin higher than PFM threshold for PFM operation to improve light load efficiency. Set this pin lower than PFM threshold for forced PWM operation.
4	ILIM	Current limitation level setting pin. Connect a resister between ILIM and GND to set over current protection level. <i>No capacitor is allowed between ILIM and AGND.</i>
5	AGND	Analog Ground.
6	RGND	Differential remote sense negative input.
7	FB	Feedback (Differential remote sense positive input). Adjust the output voltage with a resistive voltage-divider between the regulator's output and AGND.
8	TON	On-Time Setting Input. Connect a resistor between VIN and TON to set the on-time.
9-12, 29, 30	IN	Supply Input. IN is the regulator input. All IN pins must be connected together.
13-15, 21-24	LX	Switching Node.
16-20	PGND	Power Ground.
25	BST	Bootstrap Capacitor Connection. The AOZ22559QI includes an internal bootstrap diode. Connect an external capacitor between BST and LX.
26	VCC	Supply for analog functions. Bypass VCC to AGND with a 4.7μF~10μF ceramic capacitor. Place the capacitor close to VCC pin.
27	SS	Soft-Start Time Setting Pin. Connect a capacitor between SS and AGND to set the soft-start time.



#### **Absolute Maximum Ratings**

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
IN, TON to AGND	-0.3 V to +30 V
IN to LX <sup>(1)</sup>	-1.0 V to +30 V
LX to AGND <sup>(2)</sup>	-1.0 V to +30 V
BST to AGND	-0.3 V to +36 V
PGND to AGND	-0.3 V to +0.3 V
Other Pins to AGND	-0.3 V to 6 V
Junction Temperature (T <sub>J</sub> )	+150°C
Storage Temperature (T <sub>s</sub> )	-65°C to +150°C
ESD Rating-HBM <sup>(3)</sup>	2kV
ESD Rating-CBM	1kV

# **Recommended Operating Conditions**

The device is not guaranteed to operate beyond the Maximum Recommended Operating Conditions.

Parameter	Rating
Supply Voltage (V <sub>IN)</sub>	5.5 V to 25 V
Output Voltage Range	0.6 V to 0.85 V*V <sub>IN</sub>
Ambient Temperature (T <sub>A</sub> )	-40°C to +85°C
Package Thermal Resistance $(\Theta_{JA})$ $(\Theta_{JC})$	32°C/W 4°C/W

#### Notes:

- 2. LX to PGND Transient (t<20ns) ------- -7V to Vin+7V.
- 3. Devices are inherently ESD sensitive, handling precautions are required. Human body model rating:  $1.5k\Omega$  in series with  $100\,pF$ .

#### **Electrical Characteristics**

 $T_A = 25$  °C,  $V_{IN} = 12$  V,  $V_{CC} = 5$  V, EN = 5 V, unless otherwise specified. Specifications in **BOLD** indicate a temperature range of -40 °C to +85 °C

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V <sub>IN</sub>	IN Supply Voltage		5.5		25	V
V <sub>IN_UVLO</sub>	Under-Voltage Lockout Threshold of V <sub>IN</sub>	V <sub>IN</sub> rising V <sub>IN</sub> falling	2.9	3.5 3.2	3.8	V V
V <sub>VCC_UVLO</sub>	Under-Voltage Lockout Threshold of V <sub>CC</sub>	V <sub>CC</sub> rising V <sub>CC</sub> falling	3.9	4.5 4.1	4.7	V
Iq	Quiescent Supply Current of V <sub>CC</sub>	I <sub>OUT</sub> = 0A, V <sub>EN</sub> > 2V, PFM mode		400		μA
I <sub>OFF</sub>	Shutdown Supply Current	V <sub>EN</sub> = 0V		15		μΑ
V <sub>REF</sub>	Reference Voltage	T <sub>A</sub> = 25°C	0.594	0.600	0.606	V
I <sub>FB</sub>	FB Input Bias Current	,,			200	nA
Enable/PFM						
V <sub>EN</sub>	EN Input Threshold	Off threshold On threshold	1.2		0.5	V V
V <sub>EN_HYS</sub>	EN Input Hysteresis		100	250		mV
V	PFM / PWM threshold	PFM Mode threshold Force PWM threshold	1.7 1.2		5 1.4	V



# **Electrical Characteristics**

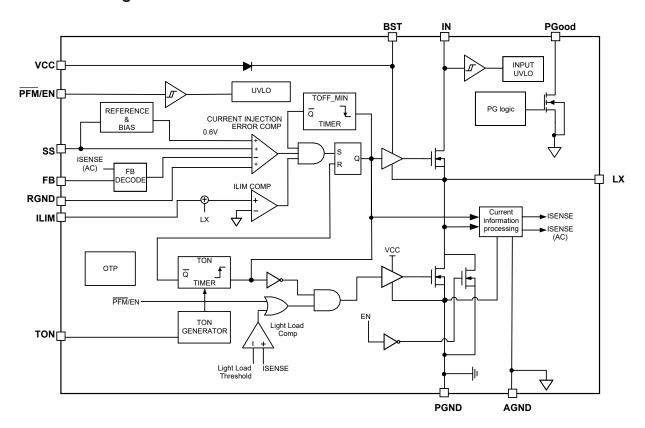
 $T_A$  = 25 °C,  $V_{IN}$  = 12 V,  $V_{CC}$  = 5 V, EN = 5 V, unless otherwise specified. Specifications in **BOLD** indicate a temperature range of -40 °C to +85 °C

Symbol Parameter		Conditions	Min	Тур	Max	Units
Modulator						
T <sub>ON</sub>	On-time	$R_{TON} = 100 k\Omega, V_{IN} = 12 V$		200		ns
T <sub>ON_MIN</sub>	Minimum On-time			70		ns
T <sub>ON_MAX</sub>	Maximum On-time			3.5		μs
T <sub>OFF_MIN</sub>	Minimum Off Time			350		ns
Soft-start						
I <sub>SS_OUT</sub>	SS Source Current	$V_{SS} = 0V$ $C_{SS} = 0.001 \mu F \text{ to } 0.1 \mu F$	7	11	15	μA
Power Good S	Signal					
$V_{PG\_LOW}$	PGOOD Low Voltage	I <sub>OL</sub> = 1mA			0.5	V
	PGOOD Leakage Current				±1	μA
Current			1	'	'	
V <sub>PGH</sub>	PGOOD Threshold (Low level to High level)	FB rising	82	90	98	%
V <sub>PGL</sub>	PGOOD Threshold (High level to Low level)	FB rising FB falling	110 77	120 85	130 93	%
	PGOOD Threshold Hysteresis			5		%
Under Voltage	and Over Voltage Protection		,	'	'	
V <sub>PL</sub>	Under Voltage threshold	FB falling	40	50	60	%
V <sub>PH</sub>	Over Voltage Threshold	FB rising	110	120	130	%
Power Stage	Output			ı	J.	
R <sub>DS(ON)</sub>	High-Side NFET On- Resistance	V <sub>IN</sub> = 12V		11		mΩ
	High-Side NFET Leakage	V <sub>EN</sub> = 0V, V <sub>LX</sub> = 0V			10	μA
R <sub>DS(ON)</sub>	Low-Side NFET On- Resistance	V <sub>I X</sub> = 12V		4		mΩ
· ·	Low-Side NFET Leakage	V <sub>EN</sub> = 0V			10	μA
Thermal Prote	ection	I EN				
	Thermal Shutdown	T, rising		150		°C
		1,1,1,5,1,8				

Rev. 1.1 October 2023 www.aosmd.com Page 7 of 19



# **Functional Block Diagram**

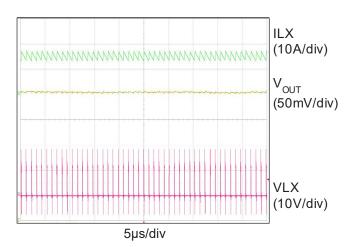




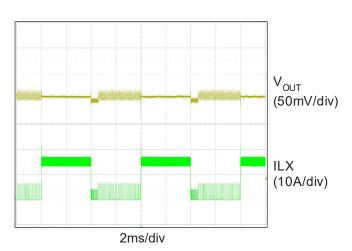
# **Typical Characteristics**

 $T_A$  = 25°C,  $V_{IN}$  = 12V,  $V_{OUT}$  = 0.77V, fs = 900kHz, unless otherwise specified.

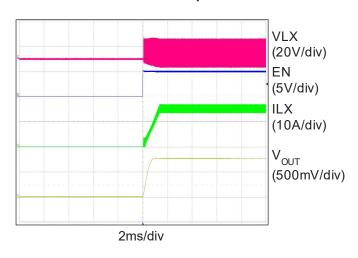
#### **Normal Operation**



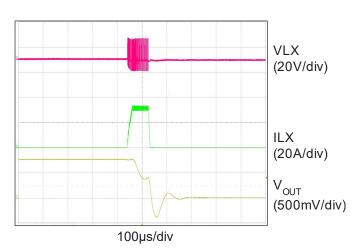
#### Load Transient 0A to 15A



#### **Full Load Start-up**



#### **Short Circuit Protection**



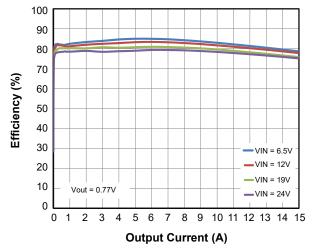


Figure 2. Efficiency vs. Load Current



#### **Detailed Description**

The AOZ22559QI is a high-efficiency, easy-to-use, synchronous buck regulator. The regulator is capable of supplying 15A of continuous output current with an output voltage adjustable down to 0.6 V. The programmable on-time from 70 ns to 3.5 µs enables optimizing the configuration for PCB area and efficiency.

The input voltage of AOZ22559QI can be as low as 5.5V. The highest input voltage of AOZ22559QI can be 25V. Constant on-time PWM with input feed-forward control scheme results in ultra-fast transient response while maintaining relatively constant switching frequency over the entire input range. True AC current mode control scheme guarantees the regulator can be stable with ceramics output capacitor. The switching frequency can be externally programmed. Protection features include  $V_{\rm CC}$  under-voltage lockout, current limit, output over voltage and under voltage protection, short-circuit protection, and thermal shutdown.

The AOZ22559QI is available in 30-pin 4mm×4mm QFN package.

#### **Enable and Soft-start**

The AOZ22559QI has external soft-start feature to limit in-rush current and ensure the output voltage ramps up smoothly to regulate voltage. A soft-start process begins when  $V_{\rm CC}$  rises to 4.5V and voltage on EN pin is HIGH. An internal current source charges the external soft-start capacitor; the FB voltage follows the voltage of soft-start pin  $(V_{\rm SS})$  when it is lower than 0.6V. When  $V_{\rm SS}$  is higher than 0.6V, the FB voltage is regulated by internal precise band-gap voltage (0.6V). When  $V_{\rm SS}$  is higher than 3.3V, the PGOOD signal is high. The soft-start time for PGOOD can be calculated by the following formula:

$$T_{ss}(\mu s) = 330 * C_{ss}(nF) \tag{1}$$

If  $C_{\rm SS}$  is 1nF, the soft-start time will be 330  $\mu$  second; if  $C_{\rm SS}$  is 10nF, the soft-start time will be 3.3m second

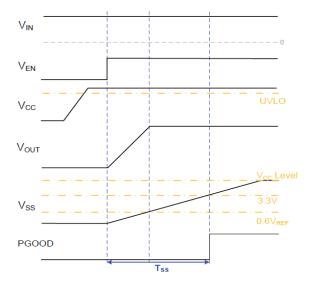


Figure 3. Soft-start Sequence of AOZ22559QI

# Constant-on-time PWM Control with Input Feed-forward

The control algorithm of AOZ22559QI is constant-on-time PWM control with input feed-forward.

The simplified control schematic is shown in Figure 4. The high-side switch on-time is determined solely by a one-shot whose pulse width can be programmed by one external resistor and is inversely proportional to input voltage (IN). The one-shot is triggered when the internal 0.6V is higher than the combined information of FB voltage and the AC current information of inductor, which is processed and obtained through the sensed lower-side MOSFET current once it turns-on. The added AC current information can help the stability of constant-on-time control even with pure ceramic output capacitors, which have very low ESR. The AC current information has no DC offset, which does not cause offset with output load change, which is fundamentally different from other V<sup>2</sup> constant-on-time control schemes.

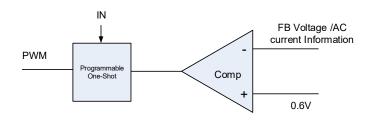


Figure 4. Simplified Control Schematic of AOZ22559QI



The constant-on-time PWM control architecture is a pseudo-fixed frequency with input voltage feed-forward. The internal circuit of AOZ22559QI sets the on-time of high-side switch inversely proportional to the IN.

$$T_{ON} \propto \frac{R_{TON}(k\Omega)}{V_{IN}(V)} \tag{2}$$

To achieve the flux balance of inductor, the buck converter has the equation:

$$F_{SW} = \frac{V_{OUT}}{V_{IN} \times T_{ON}}$$
 (3)

Once the product of Vin\*Ton is constant, the switching frequency keeps constant and is independent of input voltage.

An external resistor between the IN and TON pins sets the switching on-time according to the following curves:

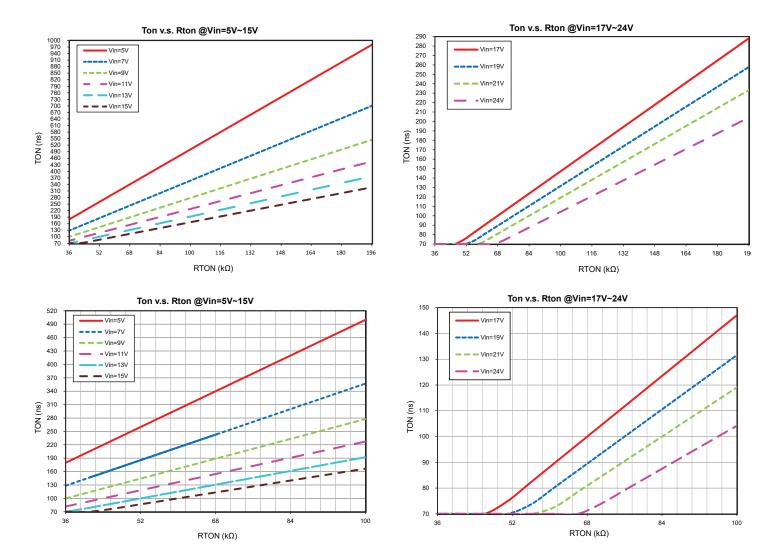


Figure 5. T<sub>on</sub> vs. R<sub>ton</sub> Curves for AOZ22559QI

Rev. 1.1 October 2023 www.aosmd.com Page 11 of 19



A further simplified equation will be:

$$F_{SW}(kHz) = \frac{V_{OUT}(V)}{V_{IN}(V)^*T_{ON}(ns)} \times 10^6$$
 (4)

If  $V_{OUT}$  is 1.05V,  $V_{in}$  is 19V, and set Fs=500kHz. According to the equation (4), Ton=110ns is needed. Finally, use the  $T_{on}$  to  $R_{ton}$  curve, we can find out  $R_{ton}$  is 82k $\Omega$ .

This algorithm results in a nearly constant switching frequency despite the lack of a fixed-frequency clock generator.

#### **True Current Mode Control**

AOS's COT control scheme uses a patented current-injection technique to provide stable performance using all-ceramic output capacitors. The constant-on-time control scheme is intrinsically unstable if output capacitor's ESR is not large enough as an effective current-sense resistor. Ceramic capacitors usually cannot be used as output capacitor.

The AOZ22559QI senses the low-side MOSFET current and processes it into DC current and AC current information using AOS proprietary technique. The AC current information is decoded and added on the FB pin on phase. With AC current information, the stability of constant-on-time control is significantly improved even without the help of output capacitor's ESR; and thus the pure ceramic capacitor solution can be applicant. The pure ceramic capacitor solution can significantly reduce the output ripple (no ESR caused overshoot and undershoot) and less board area design.

#### **Current Limit Setting**

The AOZ22559QI has the current limit function by using  $R_{\rm dson}$  of the low-side MOSFET to be as current sensing. To detect real current information, a minimum constant off (350ns typical) is implemented after a constant-on-time. If the current exceeds the current limit threshold, the PWM controller is not allowed to initiate a new cycle. The actual peak current is greater than the current limit threshold by an amount equal to the inductor ripple current. Therefore, the exact current limit characteristic and maximum load capability are a function of the inductor value and input and output voltages. The current limit will keep the low-side MOSFET on and will not allow another high-side on-time, until the current in the low-side MOSFET reduces below the current limit.

After 64 switching cycles, the AOZ22559QI considers this is a true failed condition and thus turns-off both high-side and low-side MOSFETs and latches off. Only when triggered, the enable can restart the AOZ22559QI again.

The current limit threshold mentioned in last paragraph can be setting by connecting a resistor between ILIM pin and ground. The value of the current limit resistor ( $R_{\rm ILIM}$ ) can be calculated according to the equation below. A capacitor from ILIM pin to ground would impact the current limit accuracy and is not allowed.

$$I_{L LIMIT}(A) = 1.25*R_{ILIM}(k\Omega)$$
 (5)

As shown in Figure 6, once the magnitude of switch node voltage  $V_{LX}$  is larger than  $V_{ILIM}$ , over current signal is triggered. The larger  $R_{ILIM}$  is, the higher over current threshold will be. Section Current Limit Protection describes the action when over current condition happens.

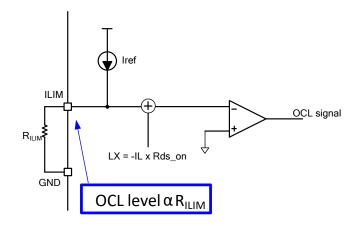


Figure 6. Illustration of Current Limit Setting

The value of current limit resistor (RILIM) must be higher than  $15k\Omega$ . The current limit calculation formula is not quaranteed if the resistor is lower than  $15k\Omega$ .

#### **Output Voltage Under-voltage Protection**

If the output voltage is lower than 50% by over-current or short circuit, AOZ22559QI turns-off both high-side and low-side MOSFET and shuts down. If the output voltage is lower than 50% by over-current or short circuit, AOZ22559QI will turns-off both high-side and low-side MOSFETs and latches off. Only when triggered, the enable can restart the AOZ22559QI again.

#### **Output Voltage Over-voltage Protection**

The threshold of OVP is set 20% higher than 0.6V. When the VFB voltage exceeds the OVP threshold, high-side



MOSFET is turn-off and low-side MOSFETs is turn-on  $1\mu s$ , then latch-off.

#### **Power Good Output**

The power good (PGOOD) output, which is an open drain output, requires the pull-up resistor. When the output voltage is 15% below than the nominal regulation voltage for, the PGOOD is pulled low. When the output voltage is 20% higher than the nominal regulation voltage, the PGOOD is also pull low.

When combined with the under-voltage-protection circuit, this current limit method is effective in almost every circumstance.

#### **Application Information**

The basic AOZ22559QI application circuit is shown in previous page. Component selection is explained below.

#### **Input Capacitor**

The input capacitor must be connected to the IN pins and PGND pin of the AOZ22559QI to maintain steady input voltage and filter out the pulsing input current. A small decoupling capacitor, usually 4.7  $\mu F$ , should be connected to the  $V_{CC}$  pin and AGND pin for stable operation of the AOZ22559QI. The voltage rating of input capacitor must be greater than maximum input voltage plus ripple voltage.

The input ripple voltage can be approximated by equation below:

$$\Delta V_{IN} = \frac{I_{OUT}}{f \times C_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times \frac{V_{OUT}}{V_{IN}}$$
 (6)

Since the input current is discontinuous in a buck converter, the current stress on the input capacitor is another concern when selecting the capacitor. For a buck circuit, the RMS value of input capacitor current can be calculated by:

$$I_{CIN\_RMS} = I_{OUT} \times \sqrt{\frac{V_{OUT}}{V_{IN}} \left(1 - \frac{V_{OUT}}{V_{IN}}\right)}$$
 (7)

if let *m* equal the conversion ratio:

$$\frac{V_{OUT}}{V_{IN}} = m \tag{8}$$

The relation between the input capacitor RMS current and voltage conversion ratio is calculated and shown in Figure. 4. It can be seen that when  $V_{OLT}$  is half of  $V_{IN}$ ,  $C_{IN}$  is

under the worst current stress. The worst current stress on  $\rm C_{IN}$  is  $\rm 0.5 \cdot I_{OUT}.$ 

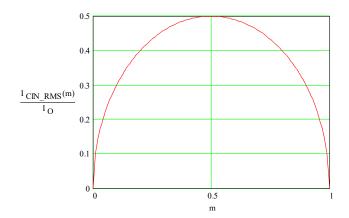


Figure 7. I<sub>CIN</sub> vs. Voltage Conversion Ratio

For reliable operation and best performance, the input capacitors must have current rating higher than I<sub>CIN-RMS</sub> at worst operating conditions. Ceramic capacitors are preferred for input capacitors because of their low ESR and high ripple current rating. Depending on the application circuits, other low ESR tantalum capacitor or aluminum electrolytic capacitor may also be used. When selecting ceramic capacitors, X5R or X7R type dielectric ceramic capacitors are preferred for their better temperature and voltage characteristics. Note that the ripple current rating from capacitor manufactures is based on certain amount of life time. Further de-rating may be necessary for practical design requirement.

#### Inductor

The inductor is used to supply constant current to output when it is driven by a switching voltage. For given input and output voltage, inductance and switching frequency together decide the inductor ripple current, which is,

$$^{\Delta I}L = \frac{V_{\text{OUT}}}{f \times L} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right)$$
 (9)

The peak inductor current is:

$$I_{Lpeak} = I_{OUT} + \frac{\Delta I_{L}}{2}$$
 (10)

High inductance gives low inductor ripple current but requires larger size inductor to avoid saturation. Low ripple current reduces inductor core losses. It also reduces RMS



current through inductor and switches, which results in less conduction loss. Usually, peak to peak ripple current on inductor is designed to be 30% to 50% of output current.

When selecting the inductor, make sure it is able to handle the peak current without saturation even at the highest operating temperature.

The inductor takes the highest current in a buck circuit. The conduction loss on inductor needs to be checked for thermal and efficiency requirements.

Surface mount inductors in different shape and styles are available from Coilcraft, Elytone and Murata. Shielded inductors are small and radiate less EMI noise. But they cost more than unshielded inductors. The choice depends on EMI requirement, price and size.

#### **Output Capacitor**

The output capacitor is selected based on the DC output voltage rating, output ripple voltage specification and ripple current rating.

The selected output capacitor must have a higher rated voltage specification than the maximum desired output voltage including ripple. De-rating needs to be considered for long term reliability.

Output ripple voltage specification is another important factor for selecting the output capacitor. In a buck converter circuit, output ripple voltage is determined by inductor value, switching frequency, output capacitor value and ESR. It can be calculated by the equation below:

$$\Delta V_{OUT} = \Delta I_{L} \times \left( ESR_{C_{o}} + \frac{1}{8 \times f \times C_{o}} \right)$$
 (11)

where  $C_O$  is output capacitor value and  $ESR_{CO}$  is the Equivalent Series Resistor of output capacitor.

When low ESR ceramic capacitor is used as output capacitor, the impedance of the capacitor at the switching frequency dominates. Output ripple is mainly caused by capacitor value and inductor ripple current. The output ripple voltage calculation can be simplified to:

If the impedance of ESR at switching frequency dominates, the output ripple voltage is mainly decided by capacitor

$$\Delta V_{OUT} = \Delta I_{L} \times \frac{1}{8 \times f \times C_{O}}$$
 (12)

ESR and inductor ripple current. The output ripple voltage calculation can be further simplified to:.

$$\Delta V_{OUT} = \Delta I_{L} \times ESR_{C_{a}}$$
 (13)

For lower output ripple voltage across the entire operating temperature range, X5R or X7R dielectric type of ceramic, or other low ESR tantalum are recommended to be used as output capacitors.

In a buck converter, output capacitor current is continuous. The RMS current of output capacitor is decided by the peak to peak inductor ripple current. It can be calculated by:

$$I_{\text{CO\_RMS}} = \frac{\Delta I_{\text{L}}}{\sqrt{12}} \tag{14}$$

Usually, the ripple current rating of the output capacitor is a smaller issue because of the low current stress. When the buck inductor is selected to be very small and inductor ripple current is high, output capacitor could be overstressed.

#### **Thermal Management and Layout Consideration**

In the AOZ22559QI buck regulator circuit, high pulsing current flows through two circuit loops. The first loop starts from the input capacitors, to the VIN pin, to the LX pins, to the filter inductor, to the output capacitor and load, and then return to the input capacitor through ground. Current flows in the first loop when the high side switch is on. The second loop starts from inductor, to the output capacitors and load, to the low side switch. Current flows in the second loop when the low side low side switch is on.

In PCB layout, minimizing the two loops area reduces the noise of this circuit and improves efficiency. A ground plane is strongly recommended to connect input capacitor, output capacitor, and PGND pin of the AOZ22559QI.

In the AOZ22559QI buck regulator circuit, the major power dissipating components are the AOZ22559QI and the output inductor. The total power dissipation of converter circuit can be measured by input power minus output power.

$$P_{\text{total loss}} = V_{\text{IN}} \times I_{\text{IN}} - V_{\text{OUT}} \times I_{\text{OUT}}$$
 (15)

The power dissipation of inductor can be approximately calculated by DCR of inductor and output current.



$$P_{inductor\_loss} = I_{OUT}^{2} \times R_{inductor} \times 1.1$$
 (16)

The actual junction temperature can be calculated with power dissipation in the AOZ22559QI and thermal impedance from junction to ambient.

$$T_{\text{junction}} = (P_{\text{total loss}} - P_{\text{total loss}}) \times \theta_{JA} + T_{A}$$
 (17)

The maximum junction temperature of AOZ22559QI is 150°C, which limits the maximum load current capability. The thermal performance of the AOZ22559QI is strongly affected by the PCB layout. Extra care should be taken by users during design process to ensure that the IC will operate under the recommended environmental conditions.

Rev. 1.1 October 2023 www.aosmd.com Page 15 of 19

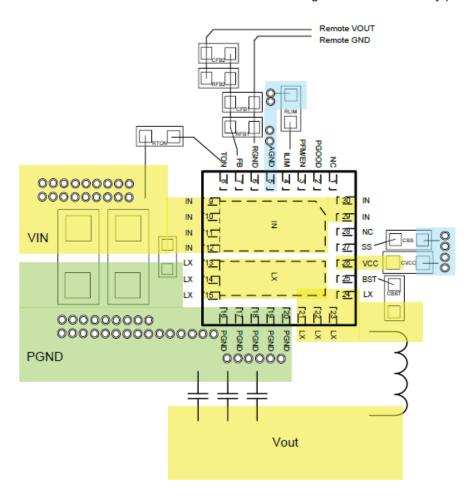


#### **Layout Considerations**

Several layout tips are listed below for the best electric and thermal performance.

- The LX pins and pad are connected to internal low side switch drain. They are low resistance thermal conduction path and most noisy switching node. Connected a copper plane to LX pin to help thermal dissipation. The inductor need to be placed as close to LX pin as possible.
- The IN pins and pad are connected to internal high side switch drain. They are also low resistance thermal conduction path. Connected a large copper plane to IN pins to help thermal dissipation.
- Connect a large PGND copper plane to PGND pin. Thick and short PGND trace could keep power path impedance low.
- Input decoupling capacitors should be connected to the IN pin and the PGND pin as close as possible to reduce the switching spikes.
- 5. Decoupling capacitor  $C_{VCC}$  should be connected to  $V_{CC}$  and GND as close as possible. Connect this GND to

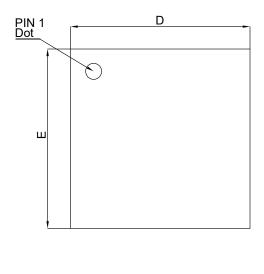
- GND layer with vias as shown in below figure. Place  $C_{\text{VCC}}$  on the same layer with IC.
- 6. Connect AGND to GND layer with vias right close to AGND pin as shown in below figure.
- 7. Voltage divider R1 and R2 should be placed as closes possible to FB and RGND. Place R1 and R2 on the same layer with IC.
- 8. RTON should be connected as close as possible to Pin 6 (TON pin). Place RTON on the same layer with IC.
- Sensitive signal traces such as feedback trace must be shielded from all noise sources, especially the LX node.
- 10. The feedback trace should be taken directly from output capacitor pad and use thin trace. FB trace goes through other layer and shielded by GND layer is acceptable.
- 11. No signal should run on nearby layer under the Lx trace or under the inductor.
- 12. Pour copper plane on all unused board area and connect it to stable DC nodes, like VIN, GND or VOUT.
- 13. Insert at least two inner layers (or planes) connected to the power ground, in order to shield and isolate the small signal traces from noisy power lines.

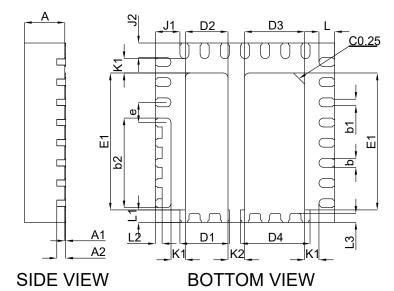


Rev. 1.1 October 2023 **www.aosmd.com** Page 16 of 19



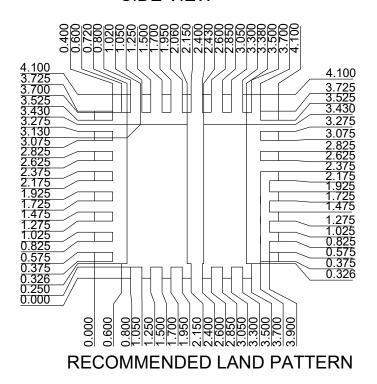
#### Package Dimensions, QFN4x4-30L





**TOP VIEW** 





SYMBOL	D	IM. IN M	1M	DIM. IN INCH		
STIVIBUL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	0.80	0.90	1.00	0.03	0.035	0.039
A1	0.00		0.05	0.000		0.002
A2		0.20 RE	F		0.008 F	REF
D	3.90	4.00	4.1	0.15	0.157	0.161
D1	1.05	1.10	1.1	0.04	0.043	0.045
D2	0.90	0.95	1.0	0.03	0.037	0.039
D3	1.29	1.34	1.3	0.05	0.053	0.055
D4	1.50	1.55	1.6	0.05	0.061	0.063
Е	3.90	4.00	4.1	0.15	0.157	0.161
E1	2.95	3.05	3.1	0.11	0.120	0.124
L	0.30	0.35	0.4	0.01	0.014	0.016
L1	0.23	0.28	0.3	0.00	0.011	0.013
L2	0.15 REF				0.006 RE	F
L3	0.20 REF				0.008 RE	F
J1	0.50	0.55	0.6	0.02	0.022	0.024
J2	0.28	0.33	0.3	0.01	0.013	0.015
K1	0.27	0.32	0.3	0.01	0.013	0.015
K2	0.32	0.37	0.4	0.01	0.015	0.017
b	0.15	0.20	0.2	0.00	0.008	0.010
b1	0.09	0.14	0.1	0.00	0.006	0.007
b2	1.95	2.00	2.0	0.07 0.079 0.081		
е		0.45 BS	C	0.018 BSC		

#### NOTE:

 CONTROLLED DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS IN INCHES ARE CONVERTED AS REFERENCE ONLY.



(12 mm)

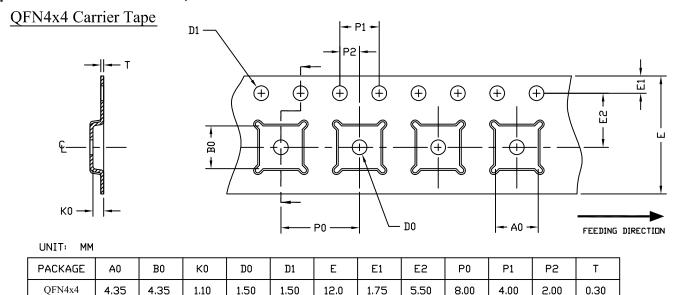
±0.10

±0.10

±0.10

MIN.

# Tape and Reel Dimensions, QFN4x4-30L



±0.3

±0.10

±0.05

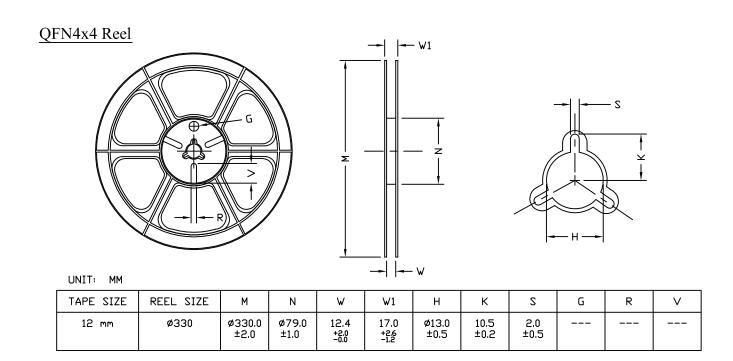
±0.10

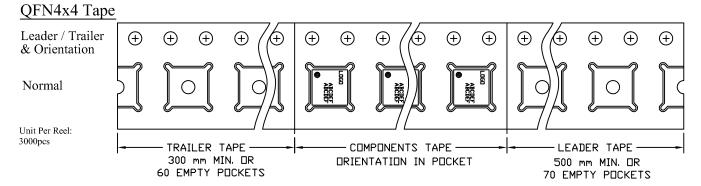
±0.10

±0.05

±0.05

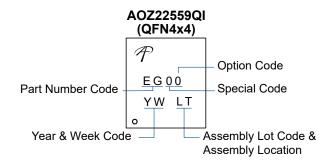
+0.1 -0.0







#### **Part Marking**



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Rev. 1.1 October 2023 **www.aosmd.com** Page 19 of 19



Document No.	PD-04891	
Version	A	
Title	AOZ22559QI/AOZ22539QI Marking Description	

#### QFN4x4 Power IC PACKAGE MARKING DESCRIPTION

PNXO
YWLT

Green product

NOTE:

LOGO - AOS Logo

PN - Part number code

X - Special electrical parameter code or region code

O - Option code Y - Year code W - Week code

L&T - Assembly lot code & Assembly location

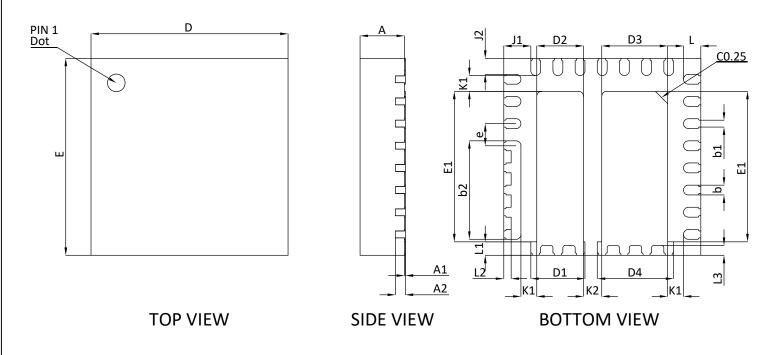
PART NO.	DESCRIPTION	CODE
AOZ22559QI	Green product	EG00
AOZ22539QI	Green product	EF00



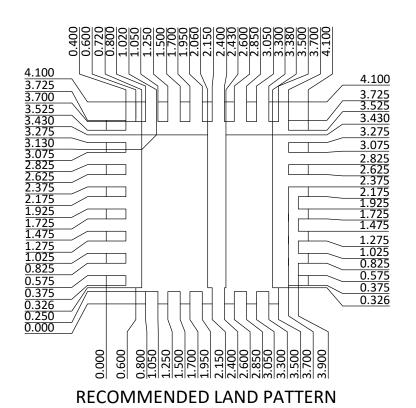
Document No. PO-00351

Version E

# QFN4x4\_30L\_EP2\_S PACKAGE OUTLINE







SYMBOLS	D	IM. IN M	Μ	D	СН	
STIVIBULS	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	0.80	0.90	1.00	0.031	0.035	0.039
A1	0.00		0.05	0.000		0.002
A2		0.20 REF			0.008 RE	F
D	3.90	4.00	4.10	0.154	0.157	0.161
D1	1.05	1.10	1.15	0.041	0.043	0.045
D2	0.90	0.95	1.00	0.035	0.037	0.039
D3	1.29	1.34	1.39	0.051	0.053	0.055
D4	1.50	1.55	1.60	0.059	0.061	0.063
E	3.90	4.00	4.10	0.154	0.157	0.161
E1	2.95	3.05	3.15	0.116	0.120	0.124
L	0.30	0.35	0.40	0.012	0.014	0.016
L1	0.23	0.28	0.33	0.009	0.011	0.013
L2	0.15 REF				0.006 RE	F
L3		0.20 REF			0.008 RE	F
J1	0.50	0.55	0.60	0.020	0.022	0.024
J2	0.28	0.33	0.38	0.011	0.013	0.015
K1	0.27	0.32	0.37	0.011	0.013	0.015
K2	0.32	0.37	0.42	0.013	0.015	0.017
b	0.15	0.20	0.25	0.006	0.008	0.010
b1	0.09	0.14	0.19	0.004	0.006	0.007
b2	1.95	2.00	2.05	0.077	0.079	0.081
е		0.45 BSC			0.018 BS	С

#### NOTE:

1. CONTROLLED DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS IN INCHES ARE CONVERTED AS REFERENCE ONLY.



# Alpha & Omega Semiconductor Product Reliability qualification Report

AOZ22559QI, rev A

**Plastic Encapsulated Device** 

**ALPHA & OMEGA Semiconductor, Inc** 

www.aosmd.com



This AOS product reliability report summarizes the qualification results for AOZ22559QI in QFN4x4\_30L package. Accelerated environmental tests are performed on a specific sample size and samples are electrically tested before and after each time point. Review of final electrical test results confirm that AOZ22559QI pass the AOS quality and reliability requirements. The released products will be categorized by its process family and routinely monitored for continuous improvement of product quality.

#### I. Reliability Stress Test Summary and Results

Test Item	Test Condition	Time Point	Total Sample Size	Number of Failures	Reference Standard
HTOL	HTOL T <sub>J</sub> = 125°C, V <sub>IN</sub> = Vccmax		231 pcs	0	JESD22-A108
Preconditioning (Note A)	T <sub>A</sub> = 30°C, RH = 60% + 3 cycle reflow @ 260°C (MSL 3)	192 hours	924 pcs	0	JESD22-A113
HAST	T <sub>A</sub> = 130°C, RH = 85%, P = 33.3psia, V <sub>IN</sub> = Vccmax	96 hours	231 pcs	0	JESD22-A110
Autoclave	T <sub>A</sub> = 121°C, RH = 100%, P = 29.7psia	96 hours	231 pcs	0	JESD22-A102
Temperature Cycle	T <sub>A</sub> = -65°C to 150°C, air to air	250 / 500 / 1000 cycles	231 pcs	0	JESD22-A104
HTSL	Temp = 150°C	500 / 1000 hours	231 pcs	0	JESD22-A103

**Note:** The reliability data presents total of available generic data up to the published date.

Note A: MSL (Moisture Sensitivity Level) 3 based on J-STD-020

#### **II. Reliability Evaluation**

FIT rate (per billion): 50.97

MTTF = 2240 years

The presentation of FIT rate for the individual product reliability is restricted by the actual burn-in sample size. Failure Rate Determination is based on JEDEC Standard JESD 85. FIT means one failure per billion hours.

Failure Rate =  $Chi^2 \times 10^9 / [2 (N) (H) (Af)] = 50.97$ MTTF =  $10^9 / FIT = 2240$  years

 $\mathbf{Chi^2} = \mathbf{Chi}\ \mathbf{Squared}\ \mathbf{Distribution},\ \mathbf{determined}\ \mathbf{by}\ \mathbf{the}\ \mathbf{number}\ \mathbf{of}\ \mathbf{failures}\ \mathbf{and}\ \mathbf{confidence}\ \mathbf{interval}$ 

**N** = Total Number of units from burn-in tests

**H** = Duration of burn-in testing

Af = Acceleration Factor from Test to Use Conditions (Ea = 0.7eV and Tuse = 55°C)

Acceleration Factor [Af] = Exp  $[Ea/k (1/T_J u - 1/T_J s)]$ 

#### **Acceleration Factor ratio list:**

	55 deg C	70 deg C	85 deg C	100 deg C	115 deg C	125 deg C
Af	77	26	9.8	3.9	1.7	1

T<sub>J</sub> s = Stressed junction temperature in degree (Kelvin), K = C + 273.16

 $T_J u$  =The use junction temperature in degree (Kelvin), K = C + 273.16

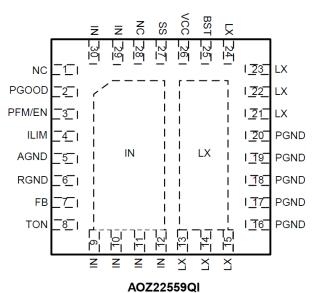
**k** = Boltzmann's constant, 8.617164 X 10<sup>-5</sup>eV / K



III. ESD and Latch Up Test Results

Test	Test Conditions	Total Sample Size	Number of Failures	Reference Standard
Electrostatic Discharge Human Body Model	T <sub>A</sub> = 25°C, +/-2kV	3 pcs	0	JS-001-2017
Electrostatic Discharge Charged Device Model	T <sub>A</sub> = 25°C, +/-1kV	3 pcs	0	JS-002-2018
Latch Up	T <sub>A</sub> = 25°C, +/-100mA, 1.5xOV	6 pcs	0	JESD78
Latch Up	T <sub>A</sub> = 125°C, +/-100mA, 1.5xOV	6 pcs	0	JESD78

(1) ATE results are used to determine PASS/FAIL. Parametric shift <10%.

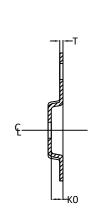


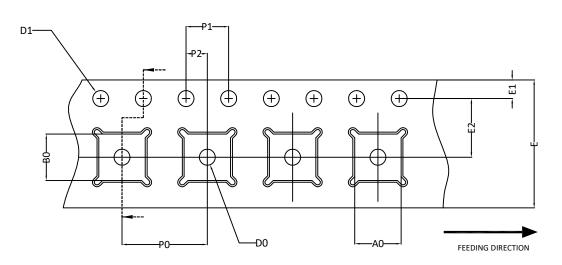
30-Pin 4mm x 4mm QFN



# QFN4x4 Tape and Reel Data

# QFN4x4 Carrier Tape

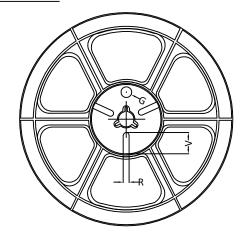




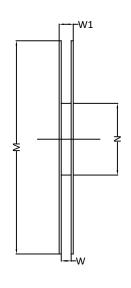
UNIT: MM

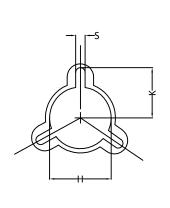
PACKAGE	A0	В0	K0	D0	D1	E	E1	E2	P0	P1	P2	Т
QFN4x4 (12 mm)	4.35 ±0.10	4.35 ±0.10	1.10 ±0.10	1.50 MIN.	1.50 +0.1 -0.0	12.0 ±0.3	1.75 ±0.10	5.50 ±0.05	8.00 ±0.10	4.00 ±0.10	2.00 ±0.05	0.30 ±0.05

# QFN4x4 Reel



**60 EMPTY POCKETS** 





70 EMPTY POCKETS

UNIT: MM

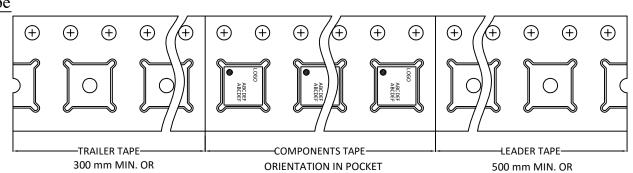
TAPE SIZE	REEL SIZE	М	N	W	W1	Н	К	S	G	R	V
12 mm	Ø330	Ø330.0 ±2.0	Ø79.0 ±1.0	12.4 +2.0 -0.0	17.0 +2.6 -1.2	Ø13.0 ±0.5	10.5 ±0.2	2.0 ±0.5			

# QFN4x4 Tape

Leader / Trailer & Orientation

Normal

Unit Per Reel: 3000pcs





# QFN4x4 Tape and Reel Data

70 EMPTY POCKETS

Leader / Trailer & Orientation

Special

Unit Per Reel: 3000pcs

